Features

- Uses advanced SGT technology
- Extremely low on-resistance R_{DS}(on)
- Excellent gate charge x R_{DS}(on) product(FOM)

Application

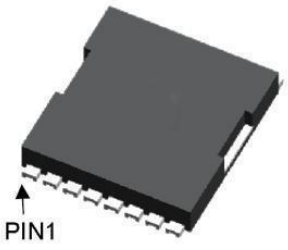
- Motor control and drive
- Battery management
- DC/DC

Product Summary

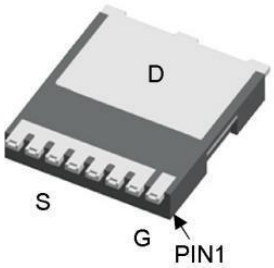
Package	TOLL
V_{DS}	40V
$R_{DS(on)@VGS=10V}$	1.42mΩ
I_D	260A

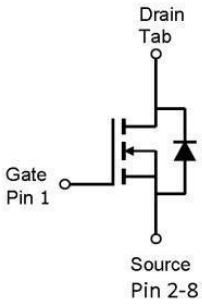
Package Marking

TOLL Top View



TOLL Bottom View





Type	Package	Marking	Reel Size	Tape Width	Packing	Qty
RST017N04SD10	TOLL	LR017N04SD10	330*28.5mm	24mm	Reel&Tape	2000

Maximum Ratings (TC=25℃unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous drain current T_c=25℃（Silicon limit） T_c=100℃（Silicon limit）	I_D	 260 165	A
Pulsed Drain Current	I_{DM}	1000	A
Maximum Power Dissipation	P_d	208	W
Single pulse avalanche energy	E_{AS}	484	mJ
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Case	R_{thJC}	0.6	℃/W
Thermal Resistance,Junction-to-Ambient	R_{thJA}	40	

Electrical Characteristics (T_C=25℃unless otherwise noted)

Parameter	Symbol	Condition	min	typ	max	Unit
Static Characteristic						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=250uA	40	-	-	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250uA	2.0	3.0	4.0	
Zero gate voltage drain current	I_{DSS}	V_{DS}=40V,V_{GS}=0V	-	-	1	μA
Gate-source leakage current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
Drain-source on-state resistance	$R_{DS(on)}$	I_D=30A,V_{GS}=10V	-	1.42	1.7	mΩ
Dynamic Characteristic						
Input Capacitance	C_{iss}	V_{DS}=20V,V_{GS}=0V, f=1MHz	-	3725	-	pF
Output Capacitance	C_{oss}		-	966	-	
Reverse Transfer Capacitance	C_{rss}		-	33	-	
Gate resistance	Rg	f=1MHz	-	2.8	-	Ω
Gate Total Charge	Q_G	V_{DS}=20V,I_D=50A, V_{GS}=10V	-	50	-	nC
Gate-Source charge	Q_{gs}		-	14	-	
Gate-Drain charge	Q_{gd}		-	8	-	
Turn-on delay time	$t_{d(on)}$	V_{GS}=10V, V_{DS}=20V, R_G=3Ω	-	4	-	ns
Rise time	t_r		-	7	-	
Turn-off delay time	$t_{d(off)}$		-	24	-	
Fall time	t_f		-	10	-	

Body Diode Characteristic

Diode Forward Voltage	V_{SD}	V_{GS}=0V,I_S=20A	-	-	1.2	v
Reverse Recovery Time	t_{rr}	I_F =20A di/dt = 100A/μs	-	39	-	ns
Reverse Recovery Charge	Q_{rr}		-	43	-	nC

Typical Performance Characteristics

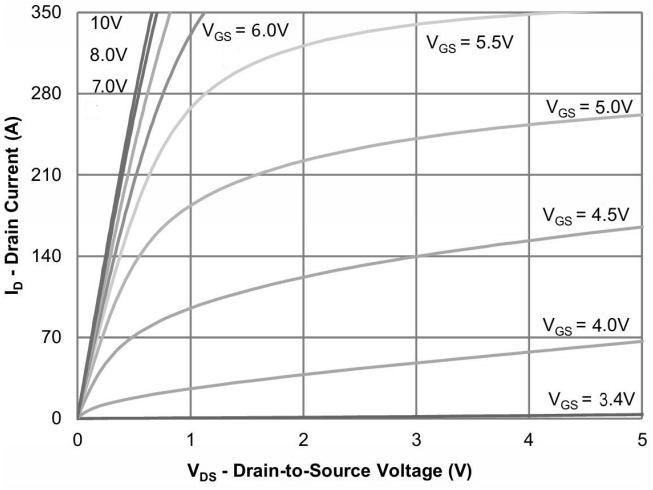


Figure 1: Output Characteristics

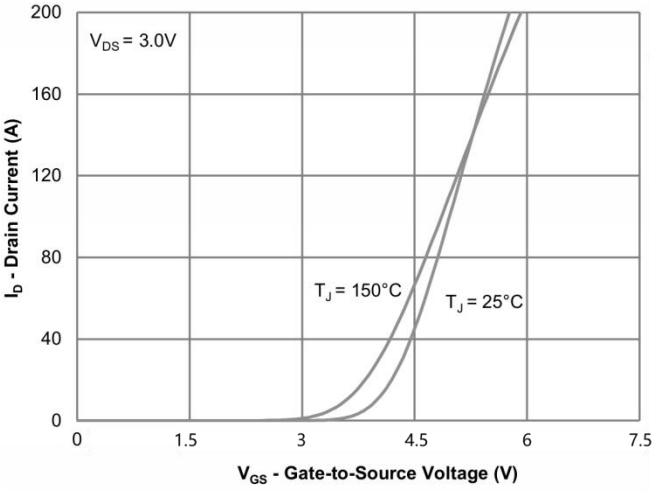


Figure 2: Transfer Characteristics

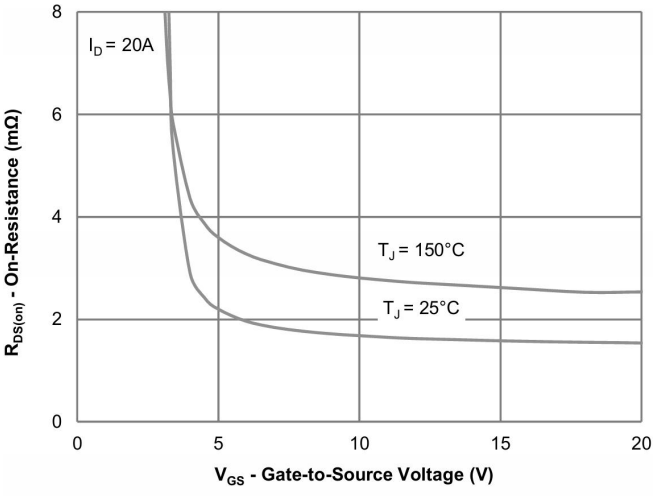


Figure 3: On-Resistance vs. Gate-Source Voltage

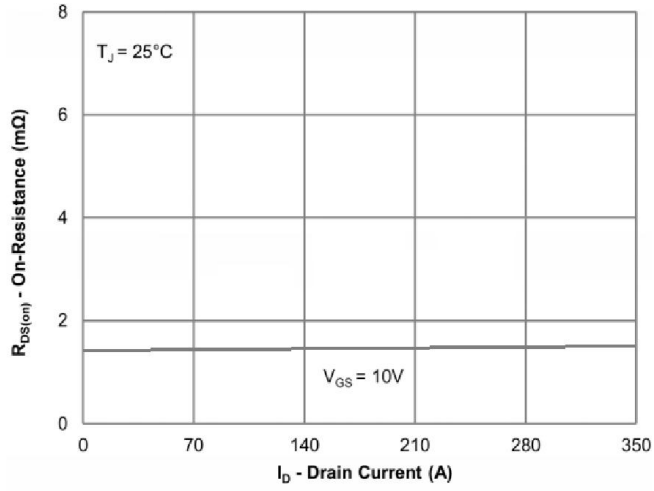


Figure 4: On-Resistance vs. Drain Current and Gate Voltage

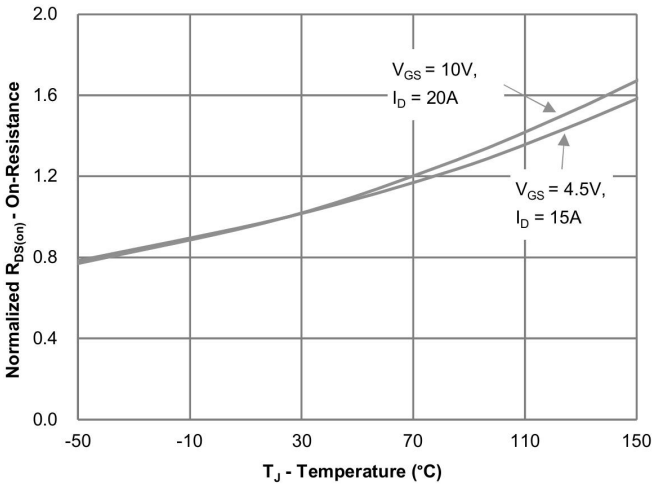


Figure 5: On-Resistance vs. Junction Temperature

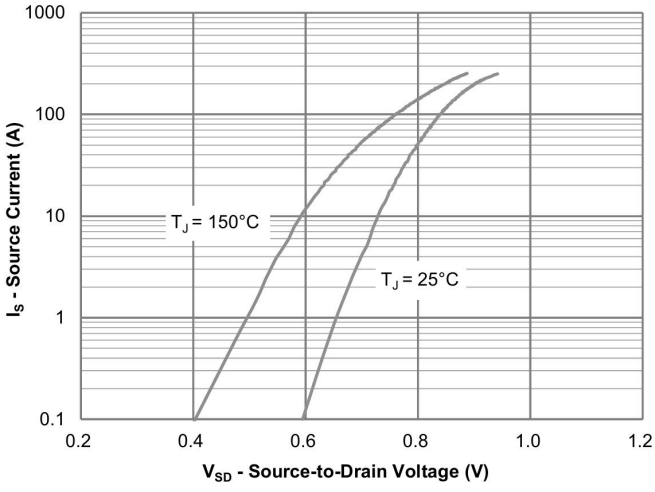


Figure 6: Source-Drain Diode Forward Voltage

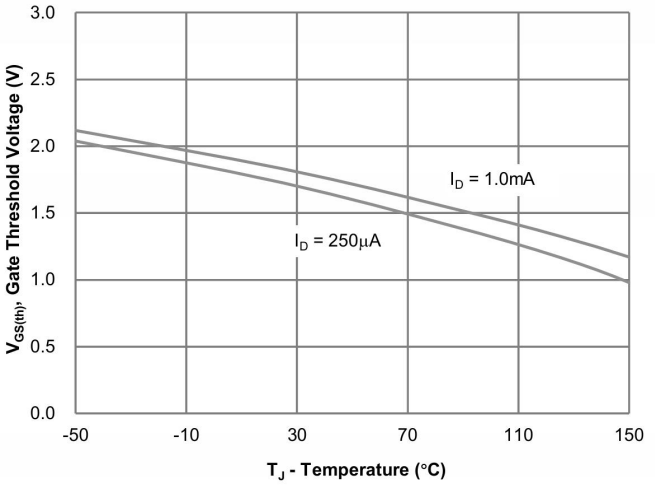


Figure 7: Gate Threshold Variation vs. Junction Temperature

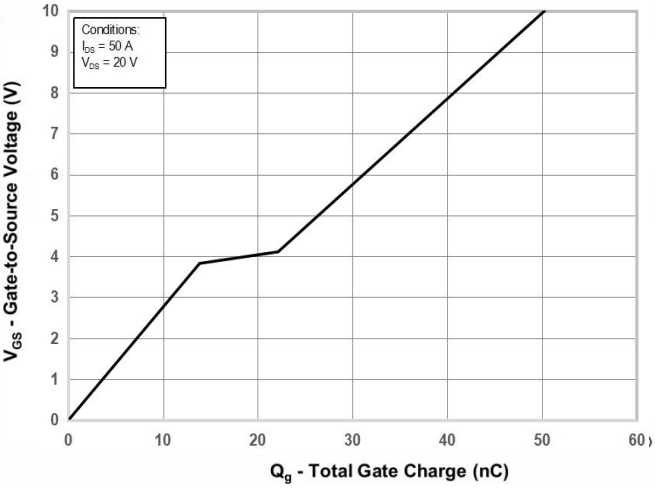


Figure 8: Gate Charge Characteristics

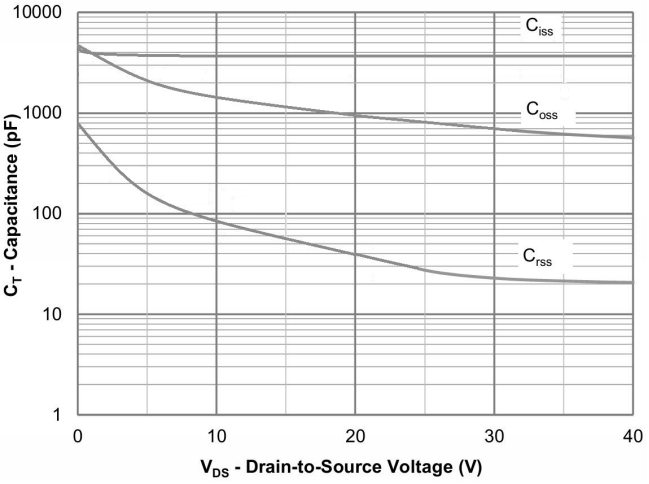


Figure 9: Capacitance Characteristics

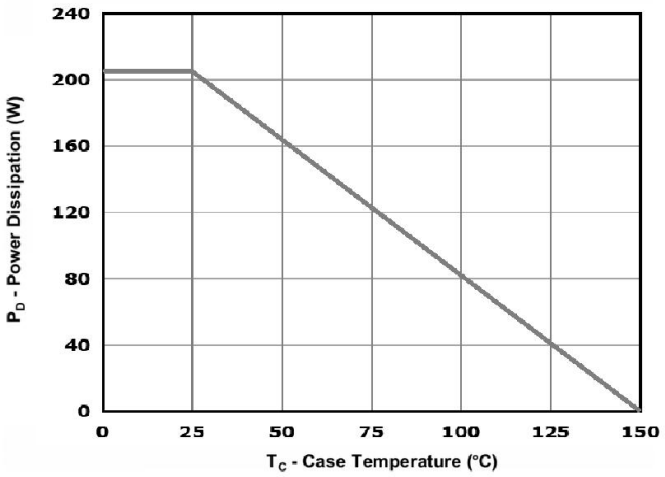


Figure 10: Power Derating

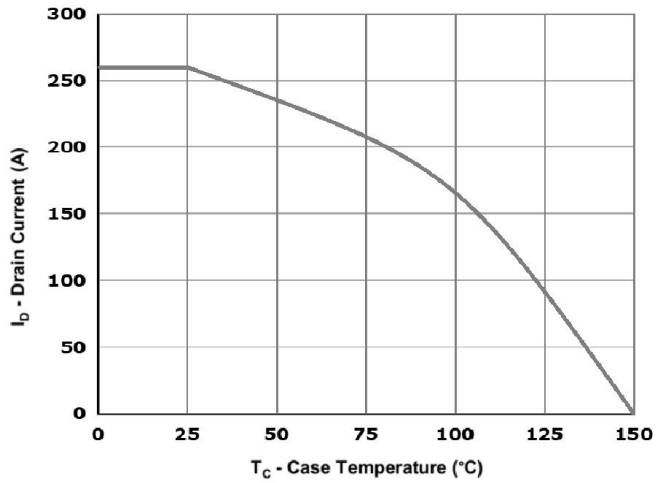


Figure 11: Current Derating

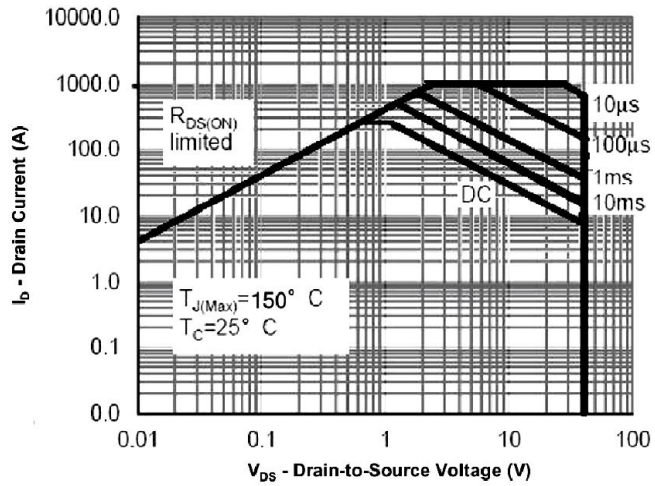


Figure 12: Safe Operating Area

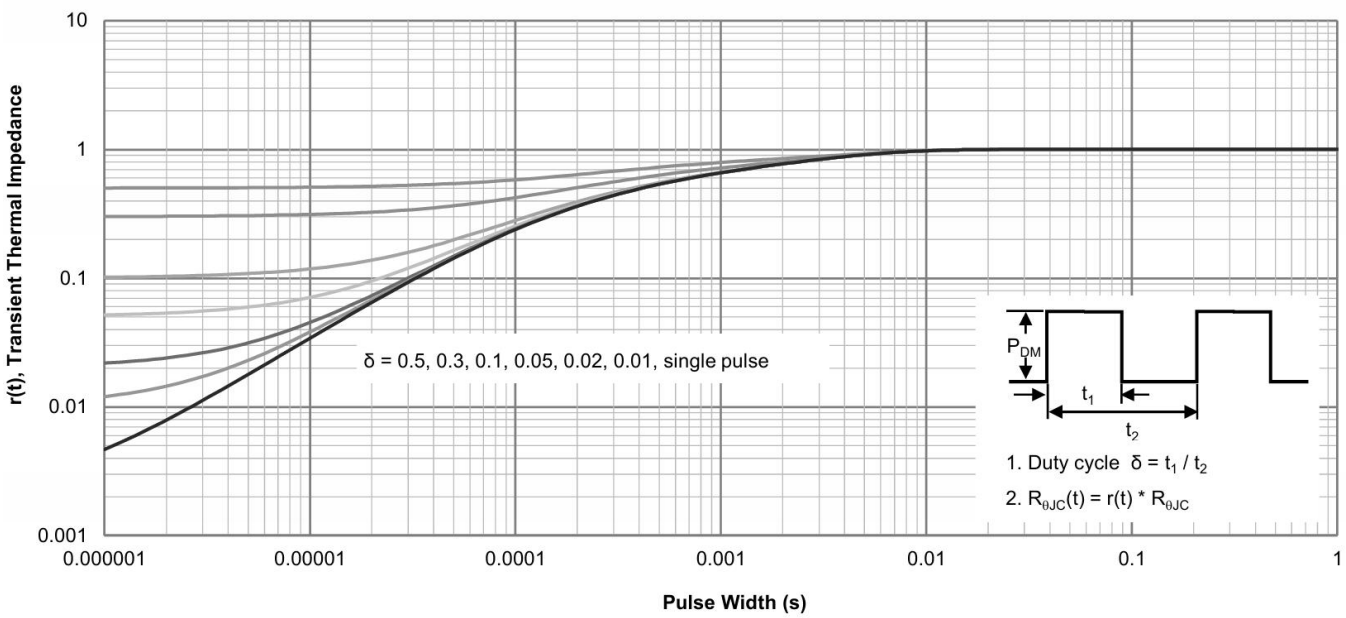
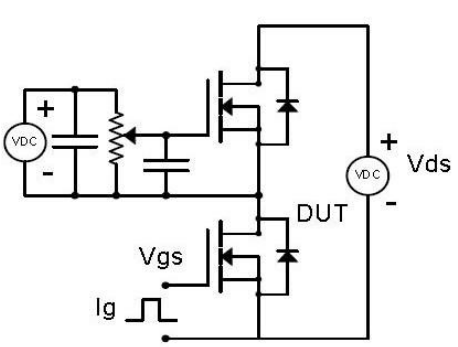
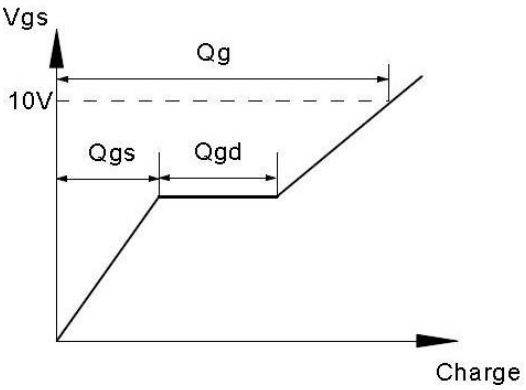


Figure 13: Normalized Maximum Transient Thermal Impedance

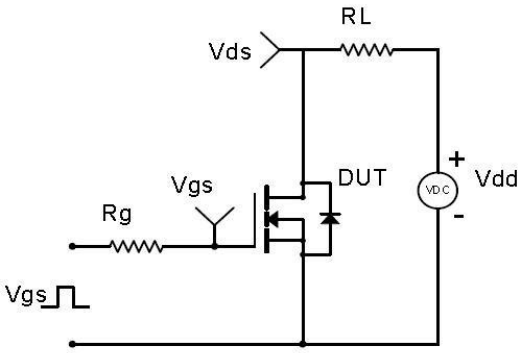
Test Circuit & Waveform

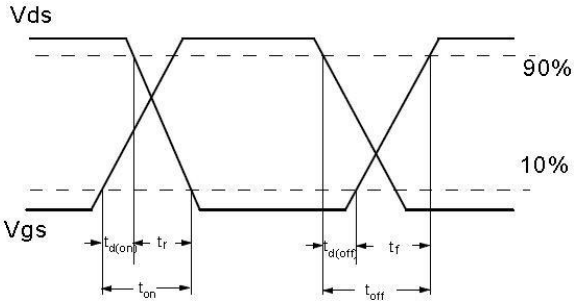
Gate Charge Test Circuit & Waveform



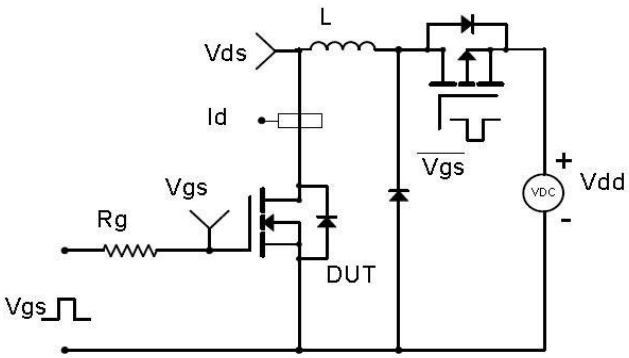


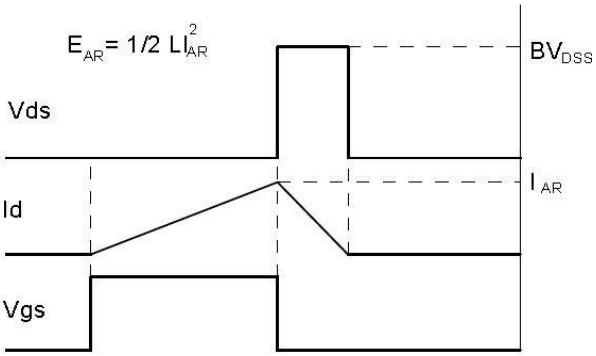
Resistive Switching Test Circuit & Waveforms



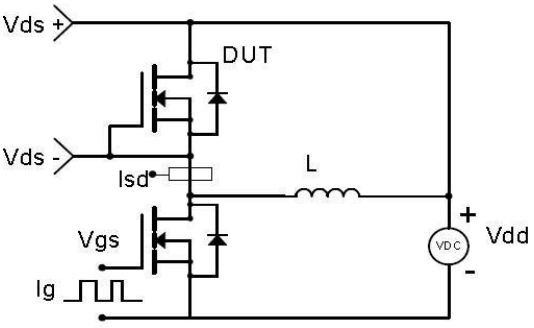


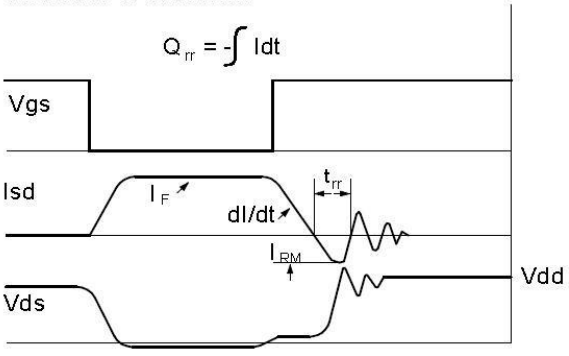
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



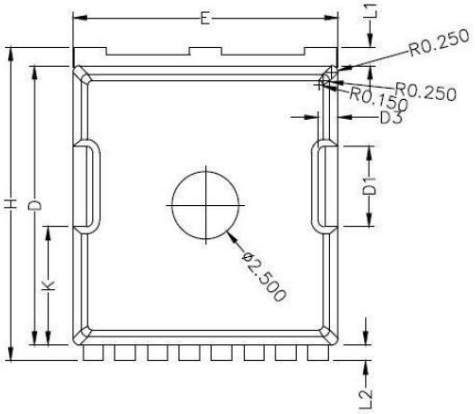


Diode Recovery Test Circuit & Waveforms

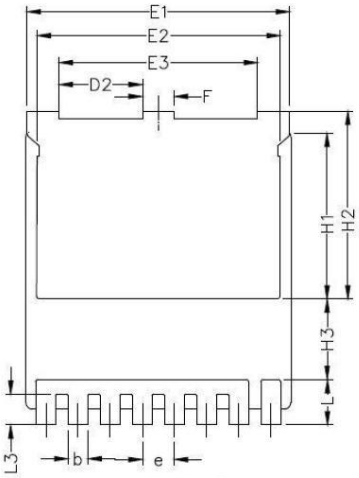




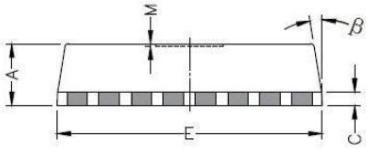
Package Outline:TOLL



Top View



Bottom View



Symbols	Millimeters		
	MIN.	NOM.	MAX.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D1	2.85	3.00	3.15
D2	2.95	3.10	3.25
D3	0.75 REF		
E	9.75	9.90	10.05
E1	9.65	9.80	9.95
E2	8.95	9.10	9.25
E3	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H1	6.03	6.18	6.33
H2	6.85	7.00	7.15
H3	3.00 BSC		
L	1.55	1.70	1.85
L1	0.55	0.70	0.85
L2	0.45	0.60	0.75
L3	1.00	1.15	1.30
M	0.08 REF		
β	8°	10°	12°
K	4.25	4.40	4.55

Revision History:

Revision	Date	Major changes
1.0	2026/04/01	Release of Preliminary version.
2.0	2026/04/29	Update Ron and Typical Performance Characteristics
3.0	2026/06/17	Update Qg and the Gate Charge Characteristics.